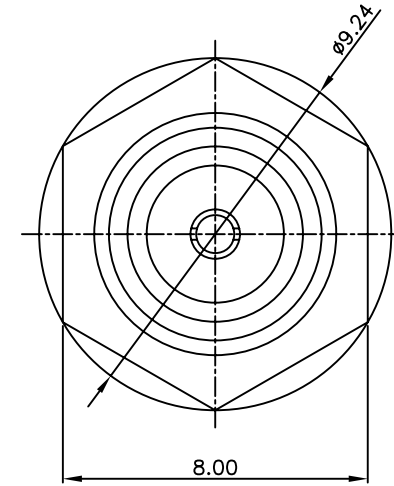
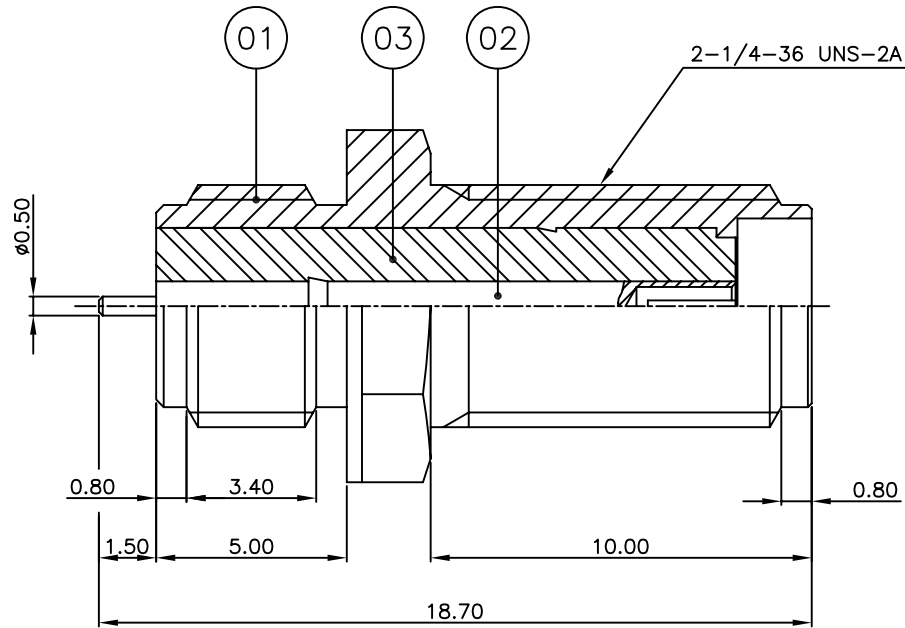


REVISION						
REV	DESCRIPTION			DRAWN	APPR	DATE
IR	Initial Registration			E.H.KIM	S.J.YOUN	2009.05.07.
1	HOOK 구조 변경			S.Y.EUN	I.C.KIM	2020.08.10.



1	3	INSULATOR	1	TEFLON		DIN01558-N/1
	2	CONTACT	1	BeCu C17300	Gold Plate	DCT01974-5/1
1	1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD02462-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 08. 10.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	±1°	CHECKED BY		TITLE SMA50 SOLDER END JB (F/F)
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	5/1	DWG NO. CN02388-7/1
		UNIT	mm	REVISION 1
				SHEET 1 of 1